

N-Channel 30V MOSFET

E030N5P8ML1

V_{DS} (V)	$R_{DS(on),max}$ (m Ω)	I_D (A)
30V	5.8 @ $V_{GS} = 10V$	40

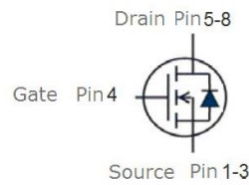
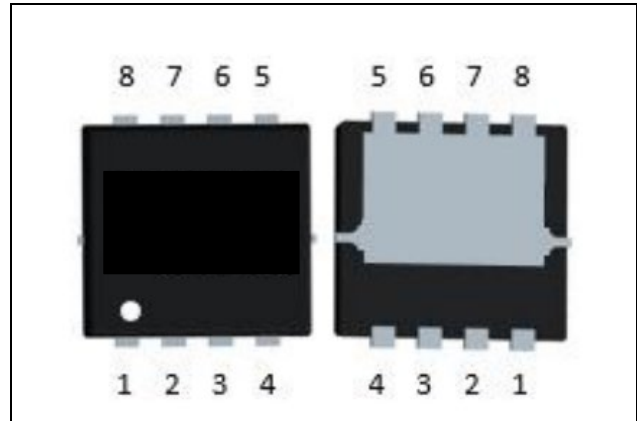
Features

- Low $R_{DS(on)}$ trench technology
- Low thermal impedance
- Fast switching speed
- 100% avalanche tested

Applications

- DC/DC conversion
- Power switch
- PD charger
- Moto driver

PDFN3.3X3.3



RoHS
COMPLIANT
HALOGEN
FREE

Package And Ordering Information

Ordering code	Package	Marking
E030N5P8ML1	PDFN3.3*3.3	EX03N40

Ordering Information

Package	Units/ Reel	Reels/ Inner Box	Units/ Inner Box
PDFN3.3*3.3	5000	1	5000

Key Performance Parameters

Parameter	Value	Unit
VDS, min @ Tj(max)	30	V
ID, pulse	160	A
RDS(ON), max @ VGS=10V	5.8	mΩ
Qg	15	nC

Absolute Maximum Ratings at Tj=25°C Unless Otherwise Noted

Parameter	Symbol	Limit	Unit
Drain-source voltage	V _{DS}	30	V
Gate-source voltage	V _{GS}	±20	
Continuous drain current	I _D	T _C =25°C	40
		T _C =100°C	30
Pulsed drain current	I _{D,pulse}	160	A
Avalanche energy, single pulse	E _{AS}	20	mJ
Power dissipation	P _D	T _C =25°C	30
		T _A =25°C	3.6
Operating junction and storage temperature range	T _J , T _{stg}	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal resistance, junction-to-case	R _{θJC}	5	°C/W
Thermal resistance, junction-to-ambient	R _{θJA}	42	

Electrical Characteristics at Tj=25°C unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test conditions
Static						
Drain to source breakdown voltage	V _{(BR)DSS}	30			V	V _{GS} = 0, I _D = 250 μA
Gate-source threshold voltage	V _{GS(th)}	1.3	1.8	2.4	V	V _{DS} = V _{GS} , I _D = 250 μA
Gate-body leakage	I _{GSS}			±100	nA	V _{DS} = 0 V, V _{GS} = ±20 V
Zero gate voltage drain current	I _{DSS}			1	μA	V _{DS} = 30 V, V _{GS} = 0 V
Drain-source on-resistance	R _{DS(on)}		4.9	5.8	mΩ	V _{GS} = 10 V, I _D = 20 A
Drain-source on-resistance	R _{DS(on)}		7.8	10.5	mΩ	V _{GS} = 4.5 V, I _D = 10 A

Gate resistance	R _g	0.2	1.9	5	Ω	f=1MHz
Gate Charge						
Total gate charge	Q _g		15	20	nC	V _{DS} = 15 V, I _D = 20A, V _{GS} = 10 V
Gate-source charge	Q _{gs}		2.9	3.9		
Gate-drain charge	Q _{gd}		3.6	5.4		
Dynamic						
Turn-on delay time	t _{d(on)}		5.6		ns	V _{DS} = 15 V, I _D = 20 A, V _{GS} = 10 V, R _{GEN} = 3 Ω
Rise time	t _r		60			
Turn-off delay time	t _{d(off)}		15			
Fall time	t _f		9.6			
Input capacitance	C _{iss}	565	750	1000	pF	V _{DS} = 15 V, V _{GS} = 0 V, f = 1MHz
Output capacitance	C _{oss}	415	550	730		
Reverse transfer capacitance	C _{rss}	55	70	95		
Body Diode						
Diode forward voltage	V _{SD}		0.9	1.2	V	V _{GS} = 0 V, I _F = 20A
Reverse recovery time	t _{rr}		10	20	ns	V _R = 0 V, I _S = 20A, di/dt = 100
Reverse recovery charge	Q _{rr}		1	2	nC	A/μs

Electrical Characteristics Diagrams

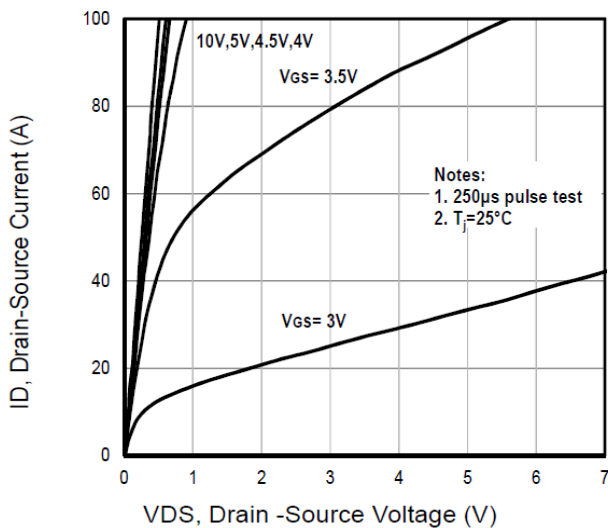


Fig1. Typical Output Characteristics

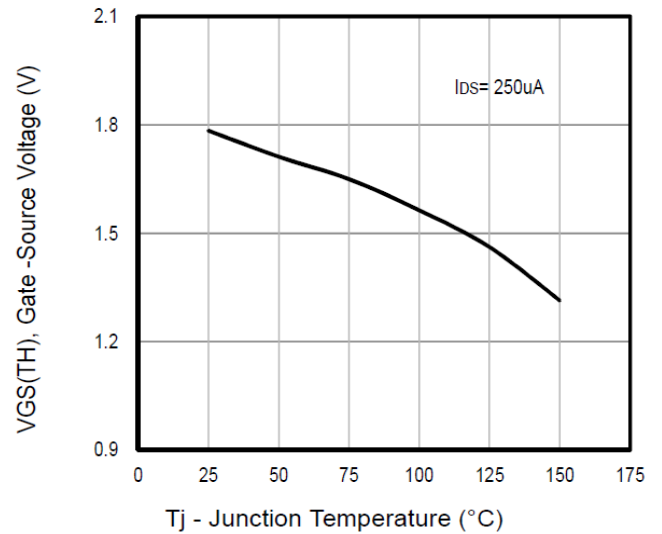


Fig2. V_{GS(TH)} Gate -Source Voltage Vs. T_j

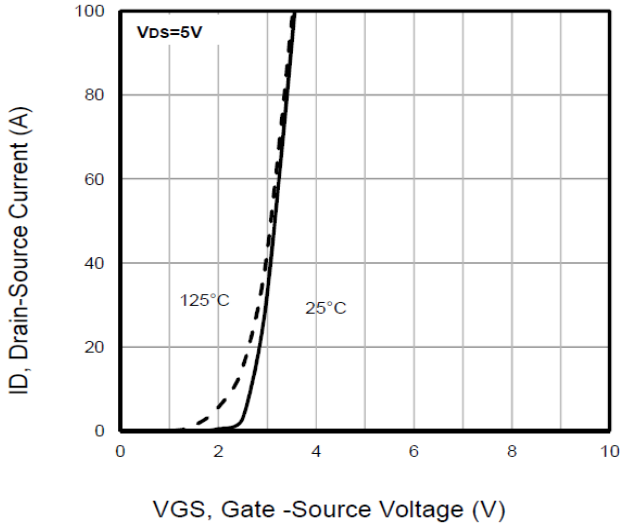


Fig3. Typical Transfer Characteristics

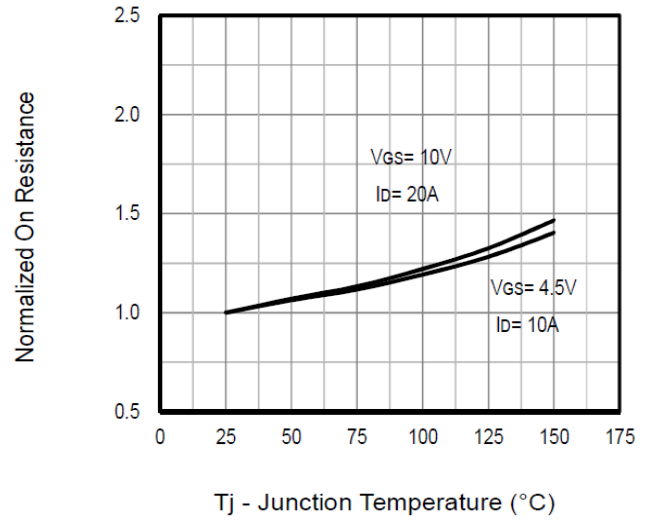


Fig4. Normalized On-Resistance Vs. Tj

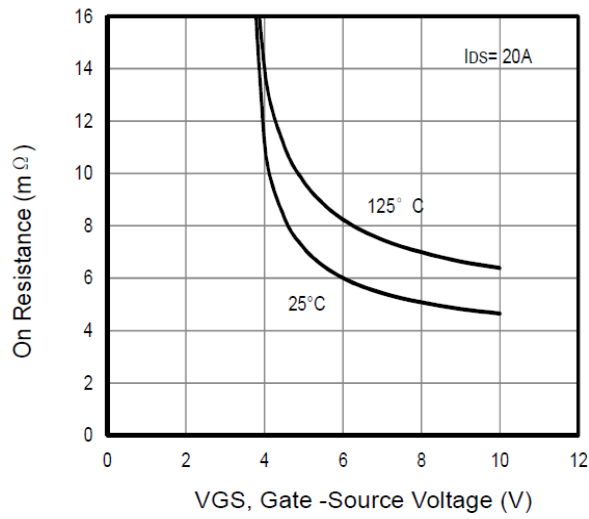


Fig5. On Resistance Vs Gate-Source Voltage

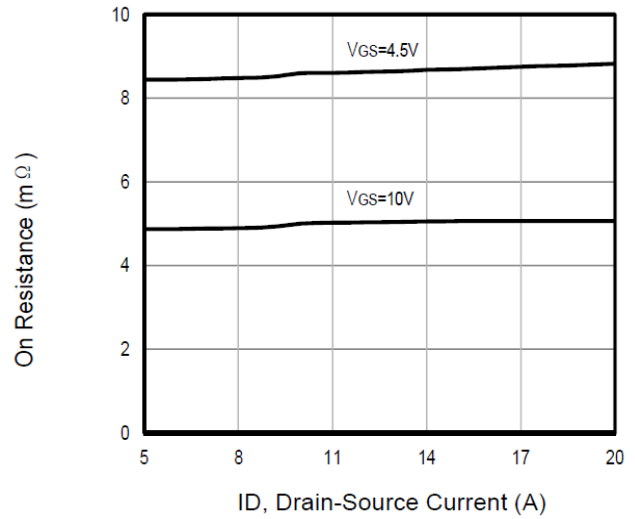


Fig6. On Resistance Vs Drain Current and Gate Voltage

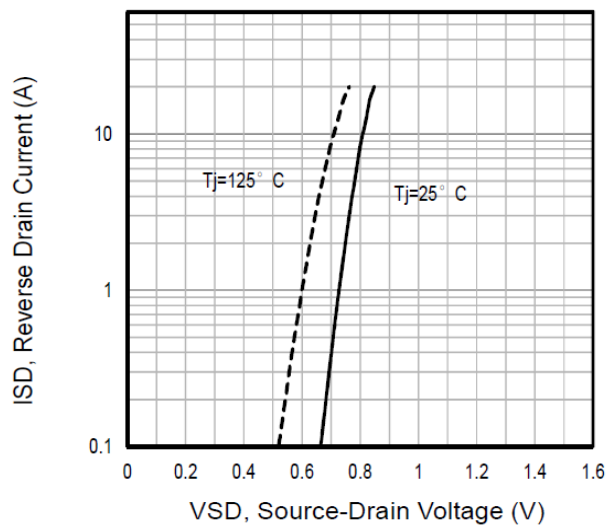


Fig7. Typical Source-Drain Diode Forward Voltage

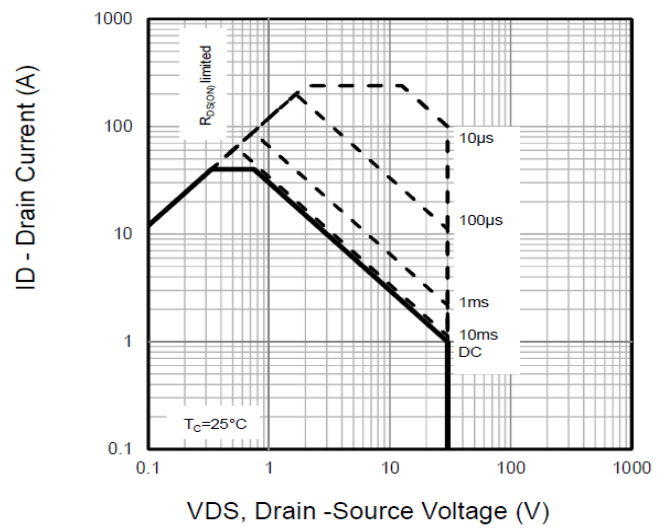


Fig8. Maximum Safe Operating Area



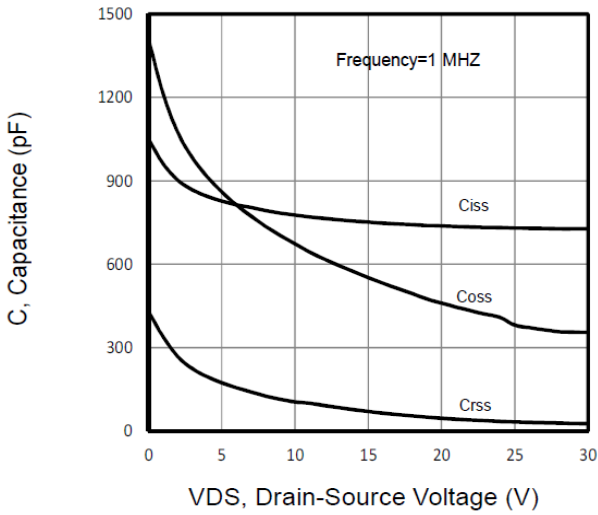


Fig9. Typical Capacitance Vs. Drain-Source Voltage

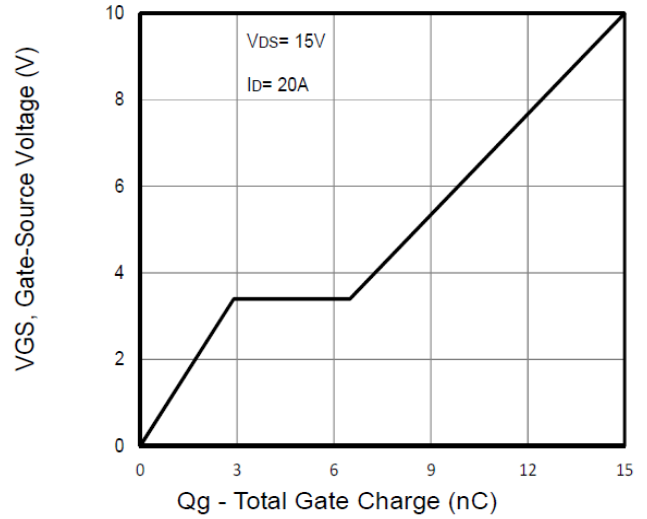


Fig10. Typical Gate Charge Vs. Gate-Source Voltage

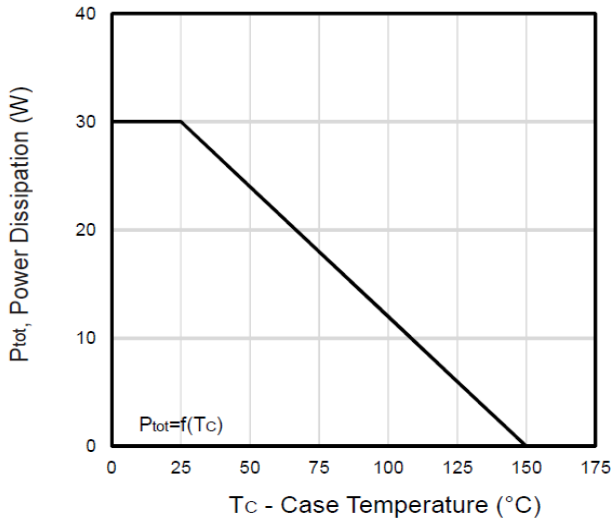


Fig11. Power Dissipation Vs. Case Temperature

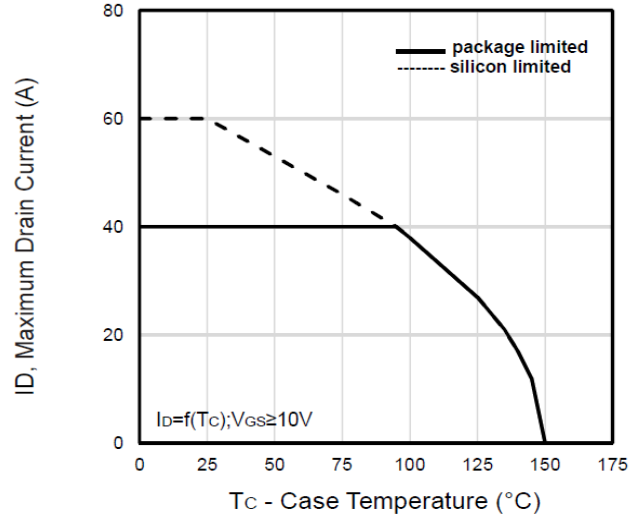


Fig12. Maximum Drain Current Vs. Case Temperature



Test circuits and waveforms

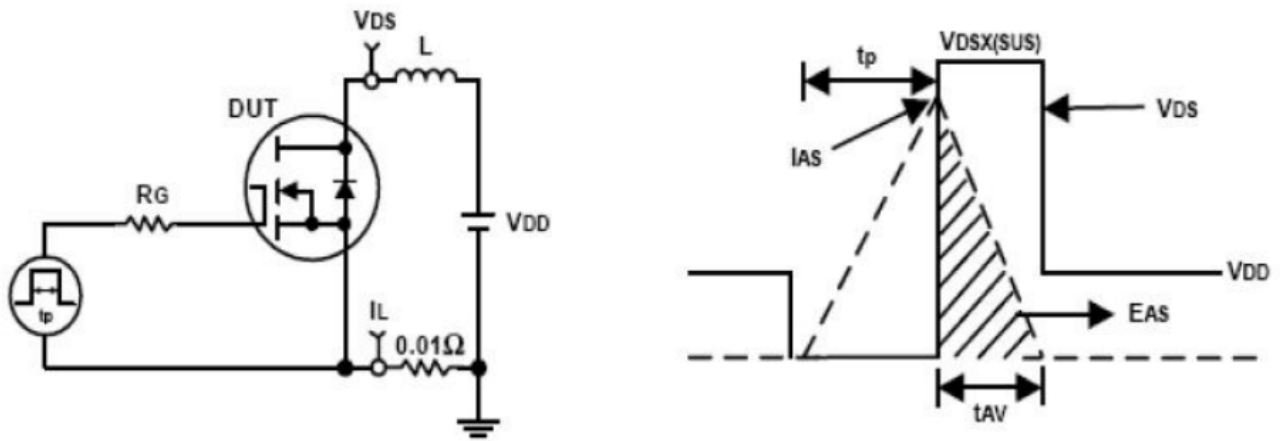


Fig1. Unclamped Inductive Test Circuit and waveforms

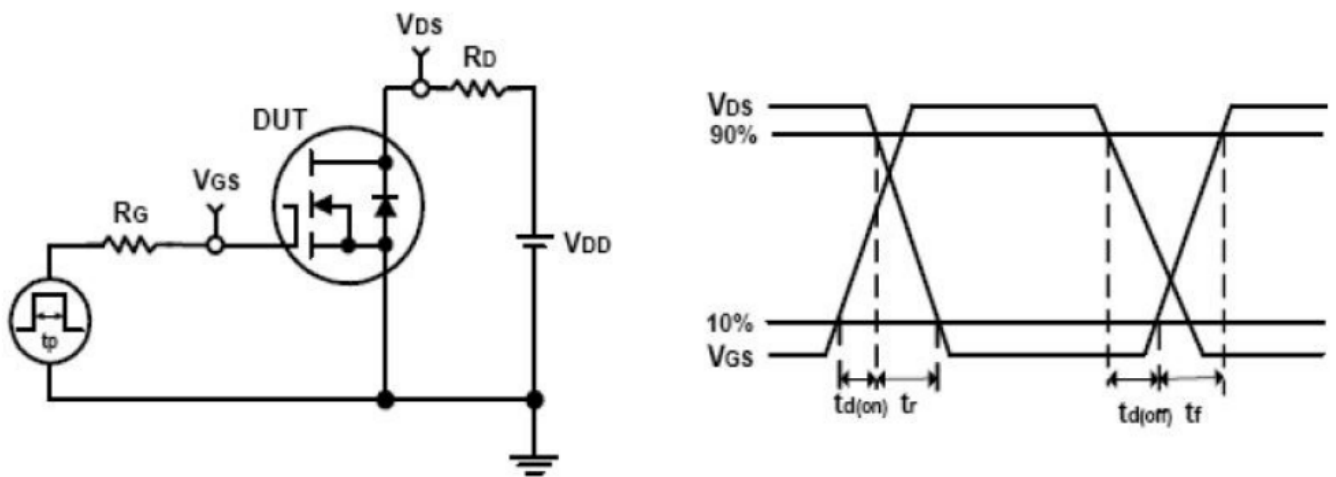
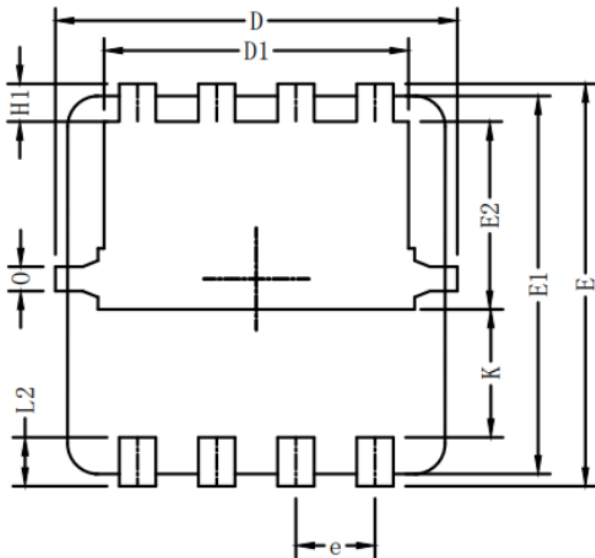
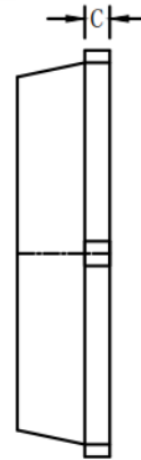
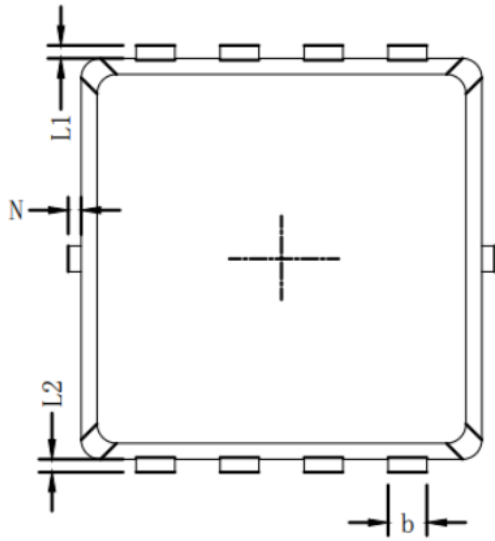


Fig2. Switching Time Test Circuit and waveforms

Package Outline Dimensions

PDFN3.3*3.3



Symbols	Millimeters		
	MIN.	NOM.	MAX.
A	0.65	0.75	0.85
b	0.25	0.30	0.35
C	0.15	0.20	0.25
D	3.00	3.10	3.20
D1	2.40	2.50	2.60
E	3.20	3.30	3.40
E1	3.00	3.10	3.20
E2	1.60	1.70	1.80
e	0.65 BSC.		
H1	0.21	0.31	0.41
H2	0.30	0.40	0.50
K	0.95	1.05	1.15
L1/L2	0.10 REF.		
θ	11°	12°	13°
N	0	-	0.15
0	0.2 REF.		

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